Unit: mm

TOSHIBA Photocoupler GaAs Ired & Photo-Triac

# TLP560G

Triac Driver **Programmable Controllers AC-Output Module** Solid State Relay

The TOSHIBA TLP560G consists of a photo-triac optically coupled to a gallium arsenide infrared emitting diode in a six lead plastic DIP package.

Peak off-state voltage: 400 V (min) • On-state current: 100 mA (max)

• Isolation voltage: 2500 Vrms (min)

• UL recognized: UL1577 File No. E67349

cUL approved: CSA Component Acceptance Service No. 5A, File No.E67349

Option (D4) VDE approved: DIN EN60747-5-5 (Note1)

Note 1: When a EN60747-5-5 approved type is needed,

please designate "Option(D4)"

$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	7.62 ± 0.25 9.50
TOSHIBA	11-7A9
Weight: 0.39g (	evp.)

Classification	Trigger LED	Marking of	
	$V_{T} = 3V$ ,	Classification	
(Note 2)	Min	Max	Ciassilication
(IFT5)	_	5	T5
(IFT7)	_	7	T5, T7
Standard	_	10	T5, T7, blank

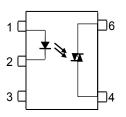
Note 2: Ex. (IFT5); TLP560G(IFT5)

Note: Application type name for certification test, please use standard product type name, i.e.

TLP560G(IFT5): TLP560G

Note: According to VDE0110, table 4.

### Pin Configuration (top view)



1: Anode

2: Cathode

3: N.C.

4: Triac Terminal

6: Triac Terminal

Start of commercial production 1982-12

#### Absolute Maximum Ratings (Ta = 25°C)

Characteristic			Symbol	Rating	Unit
Forward current			lF	50	mA
	Forward current derating (Ta ≥	53°C)	ΔI <sub>F</sub> / °C	-0.7	mA / °C
	Peak forward current (100µs p	ulse, 100pps)	lfp	1	Α
LED	Reverse voltage		VR	5	V
	Diode power dissipation		PD	100	mW
	Diode power dissipation deration	ng (Ta ≥ 53°C)	ΔP <sub>D</sub> /°C	-1.4	mW/°C
	Junction temperature	Tj	125	°C	
	Off-state output terminal voltage	ge	$V_{DRM}$	400	V
	On-state RMS current	Ta = 25°C	I	100	A
		Ta = 70°C	IT(RMS)	50	- mA
	On-state current derating (Ta ≥	25°C)	ΔI <sub>T</sub> / °C	-1.1	mA / °C
Detector	Peak on–state current (100µs pulse, 120pps)		I <sub>TP</sub>	2	Α
Dete	Peak nonrepetitive surge curre (Pw = 10ms)	nt	ITSM	1.2	Α
	Output power dissipation  Output power dissipation derating (Ta ≥ 25°C)		Ро	300	mW
			ΔP <sub>o</sub> /°C	-3.0	mW / °C
	Junction temperature	Tj	115	°C	
Storage temperature range			T <sub>stg</sub>	-55 to 125	°C
Operating temperature range		T <sub>opr</sub>	-40 to 100	°C	
Lead soldering temperature (10s)		T <sub>sol</sub> 260		°C	
Isolation voltage (AC, 60 s, R.H. ≤ 60%)			BVS	2500	V <sub>rms</sub>

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

#### **Recommended Operating Conditions**

Characteristic	Symbol	Min	Тур.	Max	Unit
Supply voltage	VAC	_	_	120	Vac
Forward current	lF	15	20	25	mA
Peak on-state current	ITP	_	_	1	Α
Operating temperature	Topr	-25	_	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

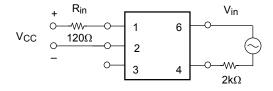
### Electrical Characteristics (Ta = 25°C)

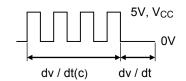
	Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	VF	IF = 10mA	1.0	1.15	1.3	V
LED	Reverse current	IR	V <sub>R</sub> = 5V	_	_	10	μA
	Capacitance	Ст	V = 0 V, f = 1 MHz	_	30	_	pF
	Peak off-state current	IDRM	V <sub>DRM</sub> = 400 V	_	10	100	nA
	Peak on-state voltage	VTM	I <sub>TM</sub> = 100 mA	_	1.7	3.0	V
ctor	Holding current	lн	_	_	0.6	_	mA
Detector	Critical rate of rise of off–state voltage	dv / dt	V <sub>in</sub> = 120 Vrms, Ta = 85 °C (Fig.1)	200	500	_	V / µs
	Critical rate of rise of commutating voltage	dv / dt(c)	V <sub>in</sub> = 30 Vrms, I <sub>T</sub> = 15 mA (Fig.1)	_	0.2	_	V / µs

## Coupled Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	I <sub>FT</sub>	V <sub>T</sub> = 3V	_	5	10	mA
Capacitance (input to output)	Cs	V <sub>S</sub> = 0 V, f = 1 MHz	_	0.8	_	pF
Isolation resistance	Rs	V <sub>S</sub> = 500 V, R.H.≤60%	5×10 <sup>10</sup>	10 <sup>14</sup>	_	Ω
	BVS	AC, 60 s	2500	_	_	\/rma
Isolation voltage		AC, 1 s, in oil	_	5000	_	Vrms
		DC, 60 s, in oil	_	5000	_	Vdc

Fig.1: dv / dt test circuit





100

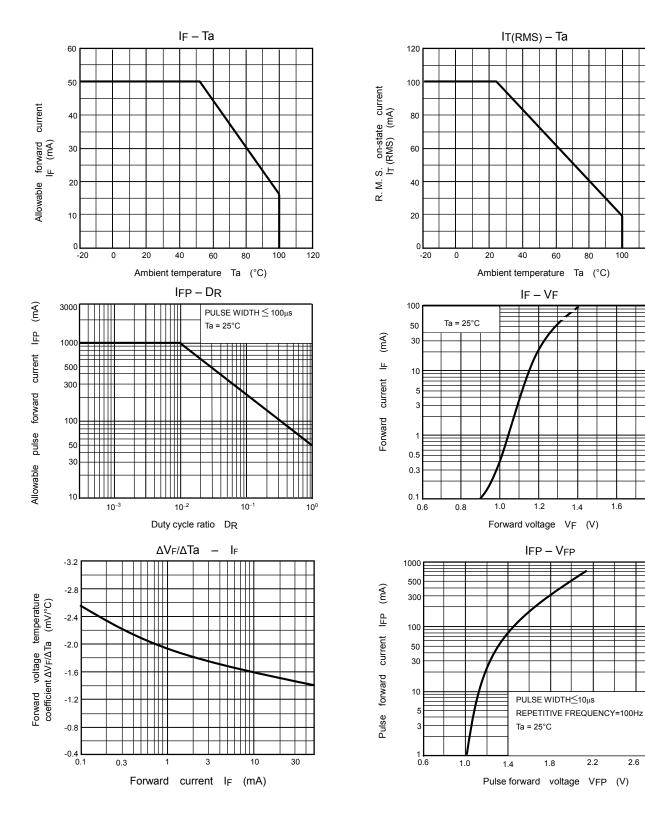
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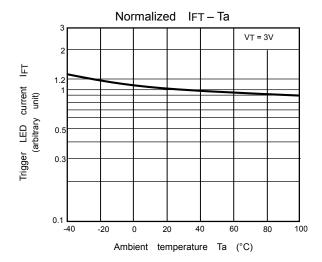
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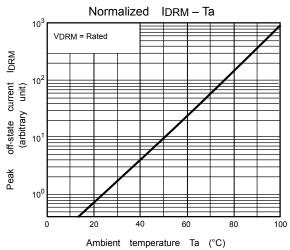
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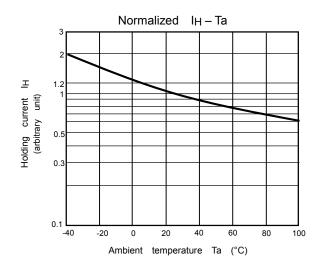
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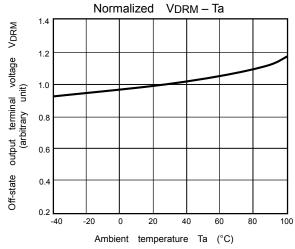
120

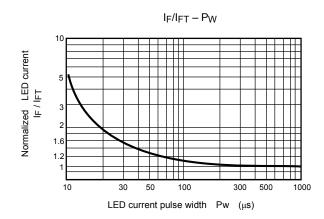












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